

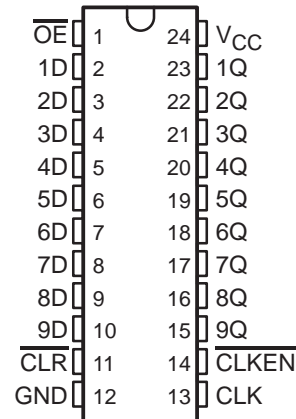
SN74LVC823A

9-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS3051 – MARCH 1993 – REVISED AUGUST 2003

- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 7.9 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <math><0.8\text{ V}</math> at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) $>2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DB, DGV, DW, NS, OR PW PACKAGE
(TOP VIEW)



description/ordering information

This 9-bit bus-interface flip-flop is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC823A is designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers with parity, and working registers.

With the clock-enable ($\overline{\text{CLKEN}}$) input low, the nine D-type edge-triggered flip-flops enter data on the low-to-high transitions of the clock. Taking $\overline{\text{CLKEN}}$ high disables the clock buffer, latching the outputs. This device has noninverting data (D) inputs. Taking the clear ($\overline{\text{CLR}}$) input low causes the nine Q outputs to go low, independently of the clock.

ORDERING INFORMATION

| T_A | PACKAGE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|---------------|--------------|-----------------------|------------------|---------|
| -40°C to 85°C | SOIC – DW | Tube of 25 | SN74LVC823ADW | |
| | | Reel of 2000 | SN74LVC823ADWR | |
| | SOP – NS | Reel of 2000 | SN74LVC823ANSR | LVC823A |
| | SSOP – DB | Reel of 2000 | SN74LVC823ADBR | LC823A |
| | TSSOP – PW | Tube of 60 | SN74LVC823APW | LC823A |
| | | Reel of 2000 | SN74LVC823APWR | |
| | | Reel of 250 | SN74LVC823APWT | |
| TVSOP – DGV | Reel of 2000 | SN74LVC823ADGVR | LC823A | |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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SN74LVC823A

9-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

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description/ordering information (continued)

A buffered output-enable (\overline{OE}) input can be used to place the nine outputs in either a normal logic state (high or low logic levels) or the high-impedance state. \overline{OE} does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

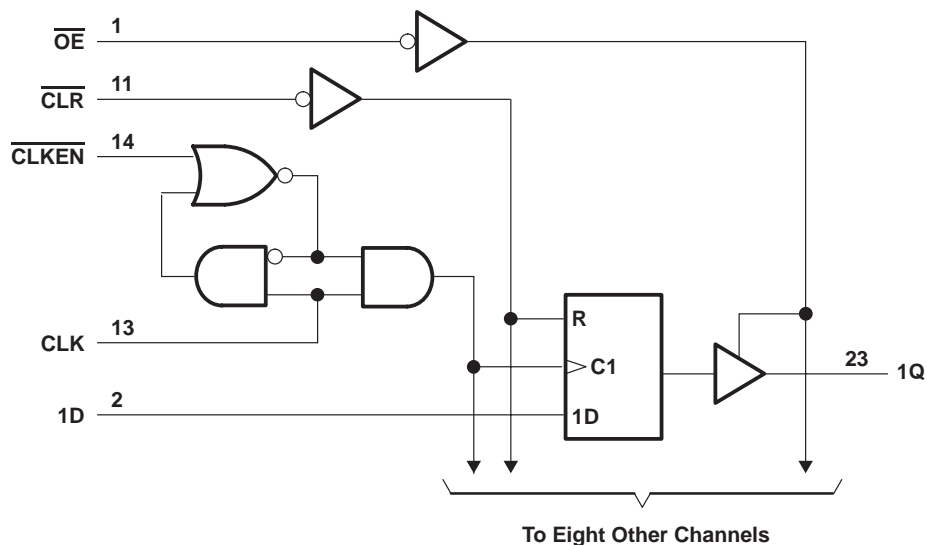
This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE
(each flip-flop)

| INPUTS | | | | | OUTPUT |
|-----------------|------------------|--------------------|-----|---|--------|
| \overline{OE} | \overline{CLR} | \overline{CLKEN} | CLK | D | Q |
| L | L | X | X | X | L |
| L | H | L | ↑ | H | H |
| L | H | L | ↑ | L | L |
| L | H | H | X | X | Q_0 |
| H | X | X | X | X | Z |

logic diagram (positive logic)



SN74LVC823A

9-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------------------|
| Supply voltage range, V_{CC} | –0.5 V to 6.5 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 6.5 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | –0.5 V to 6.5 V |
| Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2) | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | –50 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Continuous output current, I_O | ±50 mA |
| Continuous current through V_{CC} or GND | ±100 mA |
| Package thermal impedance, θ_{JA} (see Note 3): DB package | 63°C/W |
| DGV package | 86°C/W |
| DW package | 46°C/W |
| NS package | 65°C/W |
| PW package | 88°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The value of V_{CC} is provided in the recommended operating conditions table.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

| | | MIN | MAX | UNIT |
|--|-----------------------------|----------------------|----------|------|
| V_{CC} Supply voltage | Operating | 1.65 | 3.6 | V |
| | Data retention only | 1.5 | | |
| V_{IH} High-level input voltage | $V_{CC} = 1.65$ V to 1.95 V | $0.65 \times V_{CC}$ | | V |
| | $V_{CC} = 2.3$ V to 2.7 V | 1.7 | | |
| | $V_{CC} = 2.7$ V to 3.6 V | 2 | | |
| V_{IL} Low-level input voltage | $V_{CC} = 1.65$ V to 1.95 V | $0.35 \times V_{CC}$ | | V |
| | $V_{CC} = 2.3$ V to 2.7 V | 0.7 | | |
| | $V_{CC} = 2.7$ V to 3.6 V | 0.8 | | |
| V_I Input voltage | | 0 | 5.5 | V |
| V_O Output voltage | High or low state | 0 | V_{CC} | V |
| | 3-state | 0 | 5.5 | |
| I_{OH} High-level output current | $V_{CC} = 1.65$ V | | –4 | mA |
| | $V_{CC} = 2.3$ V | | –8 | |
| | $V_{CC} = 2.7$ V | | –12 | |
| | $V_{CC} = 3$ V | | –24 | |
| I_{OL} Low-level output current | $V_{CC} = 1.65$ V | | 4 | mA |
| | $V_{CC} = 2.3$ V | | 8 | |
| | $V_{CC} = 2.7$ V | | 12 | |
| | $V_{CC} = 3$ V | | 24 | |
| $\Delta t/\Delta v$ Input transition rise or fall rate | | | 10 | ns/V |
| T_A Operating free-air temperature | | –40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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9-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | MIN | TYP† | MAX | UNIT |
|------------------|--|-----------------|----------------------|------|------|------|
| V _{OH} | I _{OH} = -100 μA | 1.65 V to 3.6 V | V _{CC} -0.2 | | | V |
| | I _{OH} = -4 mA | 1.65 V | 1.2 | | | |
| | I _{OH} = -8 mA | 2.3 V | 1.7 | | | |
| | I _{OH} = -12 mA | 2.7 V | 2.2 | | | |
| | I _{OH} = -24 mA | 3 V | 2.4 | | | |
| V _{OL} | I _{OL} = 100 μA | 1.65 V to 3.6 V | | | 0.2 | V |
| | I _{OL} = 4 mA | 1.65 V | | | 0.45 | |
| | I _{OL} = 8 mA | 2.3 V | | | 0.7 | |
| | I _{OL} = 12 mA | 2.7 V | | | 0.4 | |
| | I _{OL} = 24 mA | 3 V | | | 0.55 | |
| I _I | V _I = 0 to 5.5 V | 3.6 V | | | ±5 | μA |
| I _{off} | V _I or V _O = 5.5 V | 0 | | | ±10 | μA |
| I _{OZ} | V _O = 0 to 5.5 V | 3.6 V | | | ±10 | μA |
| I _{CC} | V _I = V _{CC} or GND | 3.6 V | I _O = 0 | | 10 | μA |
| | 3.6 V ≤ V _I ≤ 5.5 V‡ | | | | 10 | |
| ΔI _{CC} | One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND | 2.7 V to 3.6 V | | | 500 | μA |
| C _i | Control inputs | 3.3 V | | | 5 | pF |
| | Data inputs | | | | 4 | |
| C _o | V _O = V _{CC} or GND | 3.3 V | | | 7 | pF |

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This applies in the disabled state only.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | V _{CC} = 1.8 V ± 0.15 V | | V _{CC} = 2.5 V ± 0.2 V | | V _{CC} = 2.7 V | | V _{CC} = 3.3 V ± 0.3 V | | UNIT |
|--------------------|-----------------|--------------------------------------|-----|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{clock} | Clock frequency | § | | § | | 150 | | 150 | | MHz |
| t _w | Pulse duration | CL _R low | | § | | 3.3 | | 3.3 | | ns |
| | | CLK high or low | | § | | 3.3 | | 3.3 | | |
| t _{su} | Setup time | CL _R inactive before CLK↑ | | § | | 1 | | 1 | | ns |
| | | Data before CLK↑ | | § | | 1.3 | | 1.3 | | |
| | | CL _{KEN} low before CLK↑ | | § | | 1.8 | | 1.8 | | |
| t _h | Hold time | Data after CLK↑ | | § | | 2 | | 2 | | ns |
| | | CL _{KEN} low after CLK↑ | | § | | 1.3 | | 1.3 | | |

§ This information was not available at the time of publication.



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9-BIT BUS-INTERFACE FLIP-FLOP
WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 1.8 V ± 0.15 V | | V _{CC} = 2.5 V ± 0.2 V | | V _{CC} = 2.7 V | | V _{CC} = 3.3 V ± 0.3 V | | UNIT |
|--------------------|--------------|-------------|-------------------------------------|-----|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | † | | † | | 150 | | 150 | | MHz |
| t _{pd} | CLK | Q | † | † | † | † | 8.9 | | 1.4 | 8 | ns |
| | CLR | | † | † | † | † | 8.8 | | 2.5 | 7.9 | |
| t _{en} | OE | Q | † | † | † | † | 8.3 | | 1.6 | 7.2 | ns |
| t _{dis} | OE | Q | † | † | † | † | 7.1 | | 1.1 | 6 | ns |
| t _{sk(o)} | | | | | | | | | 1 | | ns |

† This information was not available at the time of publication.

operating characteristics, T_A = 25°C

| PARAMETER | | TEST CONDITIONS | V _{CC} = 1.8 V | V _{CC} = 2.5 V | V _{CC} = 3.3 V | UNIT | |
|-----------------|---|------------------|-------------------------|-------------------------|-------------------------|------|----|
| | | | TYP | TYP | TYP | | |
| C _{pd} | Power dissipation capacitance per flip-flop | Outputs enabled | f = 10 MHz | † | † | 59 | pF |
| | | Outputs disabled | | † | † | 46 | |

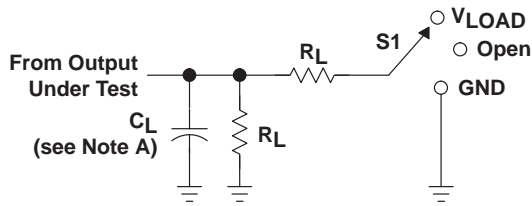
† This information was not available at the time of publication.

SN74LVC823A

9-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS3051 – MARCH 1993 – REVISED AUGUST 2003

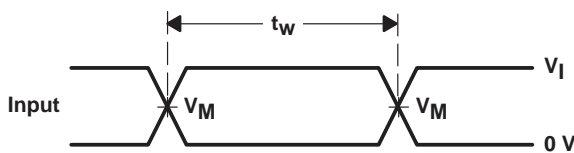
PARAMETER MEASUREMENT INFORMATION



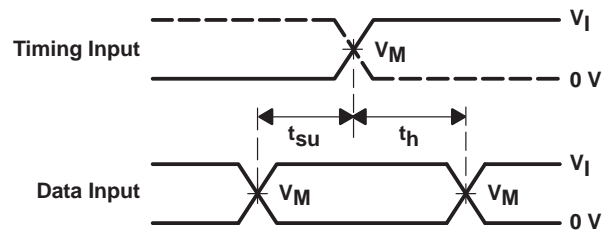
LOAD CIRCUIT

| TEST | S1 |
|-------------------|------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | V_{LOAD} |
| t_{PHZ}/t_{PZH} | GND |

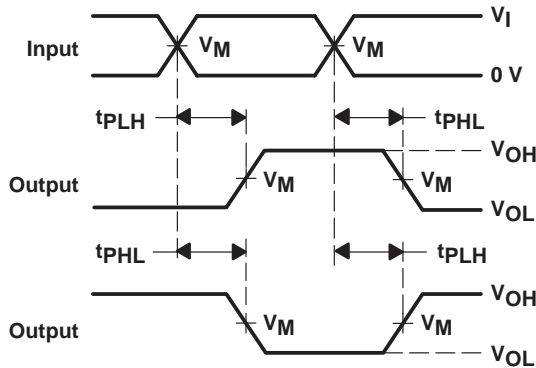
| V_{CC} | INPUTS | | V_M | V_{LOAD} | C_L | R_L | V_{Δ} |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
| | V_I | t_r/t_f | | | | | |
| $1.8\text{ V} \pm 0.15\text{ V}$ | V_{CC} | $\leq 2\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k Ω | 0.15 V |
| $2.5\text{ V} \pm 0.2\text{ V}$ | V_{CC} | $\leq 2\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 Ω | 0.15 V |
| 2.7 V | 2.7 V | $\leq 2.5\text{ ns}$ | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |
| $3.3\text{ V} \pm 0.3\text{ V}$ | 2.7 V | $\leq 2.5\text{ ns}$ | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |



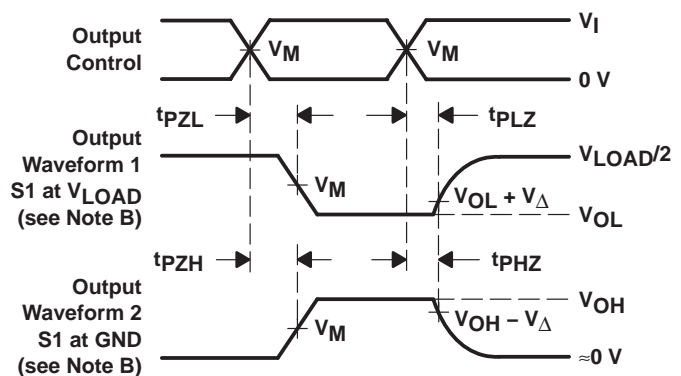
VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



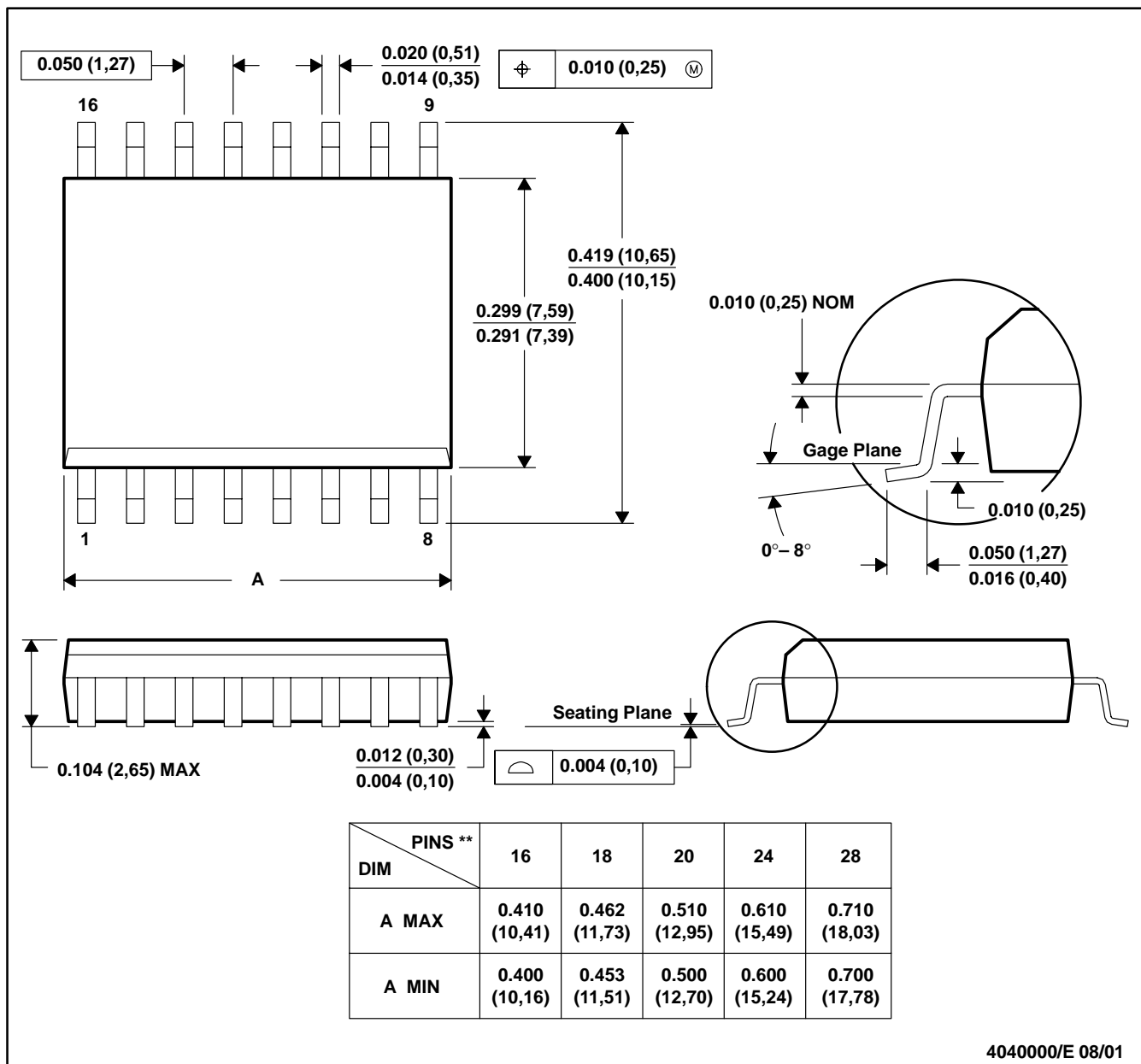
4073251/E 08/00

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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